

APPLICABLE STANDARD				
RATING	OPERATING TEMPERATURE RANGE	-30°C TO + 85°C (NOTE 1)	STORAGE TEMPERATURE RANGE	-10°C TO + 60°C (NOTE 3)
	OPERATING HUMIDITY RANGE	40% TO + 80% (NOTE 2)	STORAGE HUMIDITY RANGE	40% TO + 70% (NOTE 3)
	VOLTAGE	250V AC	CURRENT	2A

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
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CONSTRUCTION

GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X

ELECTRIC CHARACTERISTICS

CONTACT RESISTANCE	100mA (DC OR 1000 Hz).	30mΩ MAX.	X	—
INSULATION RESISTANCE	500V DC.	1000MΩ MIN.	X	—
VOLTAGE PROOF	650V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—

MECHANICAL CHARACTERISTICS

MECHANICAL OPERATION	30TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
SHOCK	490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—

ENVIRONMENTAL CHARACTERISTICS

RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55→ 5 TO 35→+85→ 5 TO 35°C TIME 30→ 2 TO 3 → 30→ 2 TO 3 min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
RESISTANCE TO SOLDERING HEAT	①AUTOMATIC SOLDERING (FLOW) SOLDER TEMPERATURE : 260°C FOR IMMERSION,DURATION : 10 sec . ②MANUAL SOLDERING SOLDERING IRON TEMPERATURE : 300°C SOLDERING TIME : 2 sec. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230°C FOR INSERTION DURATION, 3sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMersed.	X	—

REMARKS

NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT

NOTE 2:NO CONDENSING.

NOTE 3:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD, AFTER PCB BOARD, OPERATINGTEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION.

COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
△				

Unless otherwise specifid , refer to JIS C 5402.

APPROVED	TS. SAKATA	09.06.01
CHECKED	TS. FUKUSHIMA	09.06.01
DESIGNED	TH. YOSHI ZAWA	09.06.01
DRAWN	YK. NAKATSU	09.05.29

Note QT:Qualification Test AT:Assurance Test X:Applicable Test

DRAWING NO.

ELC4-162402-01

HRS	SPECIFICATION SHEET	PART NO.	DF11-*DP-2DSA (89)	
	HIROSE ELECTRIC CO., LTD.	CODE NO.	CL543	△ 1/1